IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Wan-Thai Hsu, John R. Clark, and Clark T.-C. Nguyen

Serial No.: To be Assigned

Filed: Filed Herewith

For: Method For Making Micromechanical Structures Having At Least One Lateral

Small Gap Therebetween And Micromechanical Device Produced Thereby

Attorney Docket No.: UOM 0210 PUSP 1

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97(b)(1)

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56 and § 1.97-1.98, the references listed and identified on the attached Form PTO/SB08A are being submitted herewith for consideration by the Examiner. This Statement is being filed in accordance with 37 C.F.R. § 1.97(b)(1).

While this Statement is being filed in compliance with the duty of disclosure, citation of the attached references is not to be construed as an admission that any of the references are "material" as defined under 37 C.F.R. § 1.56(b).

In accordance with 37 C.F.R. § 1.98(d), copies of the cited references are not being provided since the references were previously cited by or submitted to the Patent and Trademark Office in prior application Serial No. 09/938,411 filed August 23, 2001 (pending) of which the present application is a continuation.

Respectfully submitted,

Wan-Thai Hsu, et al.

Date: July 24, 2003

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Substitute for	Form 1449A/PTO			Complete if Known		
				Application Number	Unknown	
STATEMENT BY APPLICANT				Filing Date	Herewith	
				First Named Inventor	Wan-Thai, Hsu, et al.	
į t				Group Art Unit	Unknown	
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Sheet	1	of	2	Attorney Docket Number	UOM 0210 PUSP 1	

	U.S. PATENT DOCUMENTS						
Examiner Initials	Cite No.1	U.S. PATENT D	COCUMENT  Kind Code <sup>2</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
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Examiner I	Cite No.1	Office <sup>3</sup>	Foreign Patent Doo	ument Kind Code <sup>5</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
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Examiner	Date
Signature	Considered

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>9</sup> Applicant is to place a check mark here if English language Translation is attached.

Substitute for Form 1449B/PTO				Complete if Known		
		\I <b>^</b>		Application Number	Unknown	
INFORMATION DISCLOSURE				Filing Date	Herewith	
STATEMENT BY APPLICANT				First Named Inventor	Wan-Thai Hsu, et al.	
<u> </u>				Group Art Unit	Unknown	
<u>.</u> 	(use as many she	ets as	s necessary)	Examiner Name	Unknown	
Sheet	2	of 2 Attorney Docket Number UOM 0210 PUSP 1				
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	Examiner	Date	
	Signature	Consid	ered

<sup>\*</sup>EXAMINER: Initial if reterence considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup>Unique citation designation number. <sup>2</sup>Applicant is to place a check mark here if English language Translation is attached.